

Refine Search

Search Results -

Terms	Documents
L6 and (thick\$4 with (semiconductor or silicon))	406

Database:

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Search History

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Set Name	Query	Hit Count	Set Name result set
<i>DB=USPT; PLUR=YES; OP=OR</i>			
<u>L8</u>	L6 and (thick\$4 with (semiconductor or silicon))	406	<u>L8</u>
<u>L7</u>	L6 and (thick\$4 with (semiconductor or silicon))	406	<u>L7</u>
<u>L6</u>	L4 and bond\$3	1230	<u>L6</u>
<u>L5</u>	L4 and bond\$3	1230	<u>L5</u>
<u>L4</u>	L3 and flex\$4	1349	<u>L4</u>
<i>DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=OR</i>			
<u>L3</u>	438/106,118,121-127,455,457,458,478,479,482,483,486.ccls.	11516	<u>L3</u>
<u>L2</u>	L1 and ((semiconductor or silicon) with thick\$4)	1968	<u>L2</u>
<u>L1</u>	(bond\$3 with (silicon or semiconductor or wafer)) and (flex\$4 with substrate)	4536	<u>L1</u>

END OF SEARCH HISTORY